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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.: 10/001,472 Confirmation No. 1913  
 Applicant: Robert H. Havemann  
 Filed: 11/01/2001  
 TC/A.U.: 2815  
 Examiner: Edward J. Wojciechowicz  
 Docket No.: TI-27506  
 Customer No.: 23494  
 Title: INTEGRATED CIRCUIT HAVING A DOPED POROUS DIELECTRIC  
AND METHOD OF MANUFACTURING THE SAME

## CERTIFICATION OF FACSIMILE TRANSMISSION

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## FACSIMILE COVER SHEET

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NAME OF INVENTOR(S):	
Havemann	
TITLE OF INVENTION:	
Integrated Circuit Having Doped Porous . . .	
TI FILE NO.:	DEPOSIT ACCT. NO.:
TI-27506	20-0668
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